

# MN4050B/MN4050BS

## Hex Non-Inverting Buffer

### ■ Outline

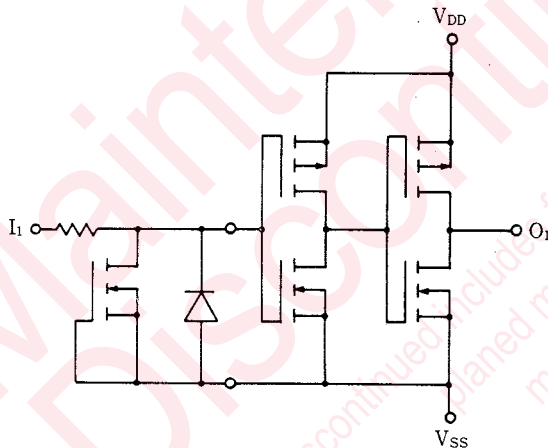
The MN4050B/S is a non-inversion type buffer having six circuits, and usable for logical level conversion.

Because of the large output current, it can directly drive TTL and DTL, and is also usable as an interface from CMOS to TTL since it can drive two standard TTL circuits.

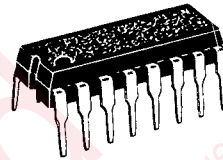
The circuits structurally constituting a 2-stage inverter assure excellent switching characteristics.

This hex non-inverting buffer is equivalent to Motorola's MC14050B and RCA's CD4050B.

### ■ Schematic Diagram (1/6) & Input Protection Circuit

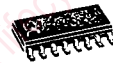


P-3



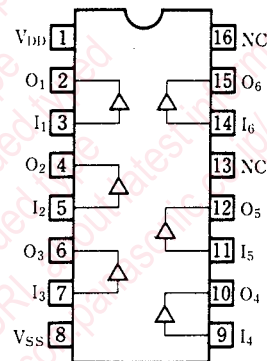
16-pin plastic DIL package

P-4



16-pin PANAFLAT package (SO-16D)

Pin Configuration



### ■ Absolute Maximum Ratings (Ta=25°C)

Item	Symbol	Rating	Unit
Supply voltage	V <sub>DD</sub>	-0.5~+18	V
Input voltage	V <sub>i</sub>	-0.5~V <sub>DD</sub> +0.5*	V
Output pin voltage	V <sub>o</sub>	-0.5~V <sub>DD</sub> +0.5*	V
Peak input · output pin current	±I <sub>i</sub>	max. 10	mA
Power dissipation (per package)	Ta=-40~+60°C	max. 400	mW
	Ta=+60~+80°C	Decrease to 200mW at the rate of 8mW/°C	
Power dissipation (per output pin)	P <sub>D</sub>	max. 100	mW
Operating ambient temperature	T <sub>opr</sub>	-40~+85	°C
Storage temperature	T <sub>stg</sub>	-65~+150	°C

\* V<sub>DD</sub>+0.5V should be lower than 18V.

### ■ Guaranteed Fan-Out for Logic Circuit Series

Driving IC	Guaranteed fan-out
Standard TTL	2
74LS	9
74L	16

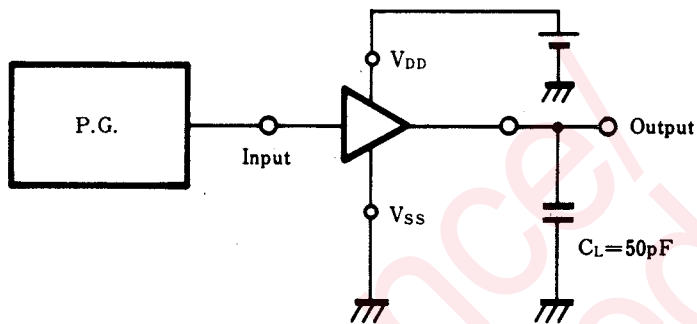
### ■ DC Characteristics ( $V_{SS}=0V$ )

Item	$V_{DD}$ (V)	Symbol	Condition	$T_a=-40^{\circ}C$		$T_a=25^{\circ}C$		$T_a=85^{\circ}C$		Unit
				min.	max.	min.	max.	min.	max.	
Static supply current	5	$I_{DD}$	$V_I=V_{SS}$ or $V_{DD}$	—	4	—	4	—	30	$\mu A$
	10			—	8	—	8	—	60	
	15			—	16	—	16	—	120	
Output voltage low level	5	$V_{OL}$	$V_I=V_{SS}$ or $V_{DD}$ $I_{O1}<1\mu A$	—	0.05	—	0.05	—	0.05	V
	10			—	0.05	—	0.05	—	0.05	
	15			—	0.05	—	0.05	—	0.05	
Output voltage high level	5	$V_{OH}$	$V_I=V_{SS}$ or $V_{DD}$ $I_{O1}<1\mu A$	4.95	—	4.95	—	4.95	—	V
	10			9.95	—	9.95	—	9.95	—	
	15			14.95	—	14.95	—	14.95	—	
Input voltage low level	5	$V_{IL}$	$I_{O1}<1\mu A$ $V_O=0.5V$ or $4.5V$	—	1.5	—	1.5	—	1.5	V
	10			—	3	—	3	—	3	
	15			—	4	—	4	—	4	
Input voltage high level	5	$V_{IH}$	$I_{O1}<1\mu A$ $V_O=0.5V$ or $4.5V$	3.5	—	3.5	—	3.5	—	V
	10			7	—	7	—	7	—	
	15			11	—	11	—	11	—	
Output current low level	4.75	$I_{OL}$	$V_O=0.4V$ , $V_O=0.5V$ , $V_I=0$ or $10V$ $V_O=1.5V$ , $V_I=0$ or $15V$	3.5	—	2.9	—	2.3	—	mA
	10			12	—	10	—	8	—	
	15			24	—	20	—	16	—	
Output current high level	5	$-I_{OH}$	$V_O=4.6V$ , $V_I=0$ or $5V$ $V_O=9.5V$ , $V_I=0$ or $10V$ $V_O=13.5V$ , $V_I=0$ or $15V$	0.52	—	0.44	—	0.36	—	mA
	10			1.3	—	1.1	—	0.9	—	
	15			3.6	—	3	—	2.4	—	
Output current high level	5	$-I_{OH}$	$V_O=2.5V$ , $V_I=0$ or $5V$	1.7	—	1.4	—	1.1	—	mA
Input leakage current	15	$\pm I_I$	$V_I=0$ or $15V$	—	0.3	—	0.3	—	1	$\mu A$

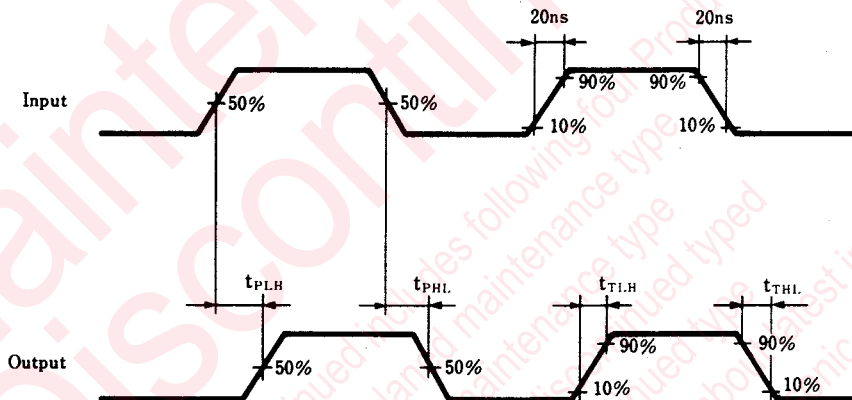
### ■ Switching Characteristics ( $T_a=25^{\circ}C$ , $V_{SS}=0V$ , $C_L=50pF$ )

Item	$V_{DD}(V)$	Symbol	min.	typ.	max.	Unit
Output rise time	5	$t_{TLH}$	—	60	180	ns
	10		—	30	90	
	15		—	20	60	
Output fall time	5	$t_{THL}$	—	25	75	ns
	10		—	10	30	
	15		—	7	21	
Propagation time	5	$t_{PLH}$	—	55	165	ns
	10		—	25	75	
	15		—	20	60	
Propagation time	5	$t_{PHL}$	—	35	105	ns
	10		—	20	60	
	15		—	15	45	
Input capacitance		$C_I$	—	—	7.5	pF

1. Switching time measuring circuit



2. Switching waveforms



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